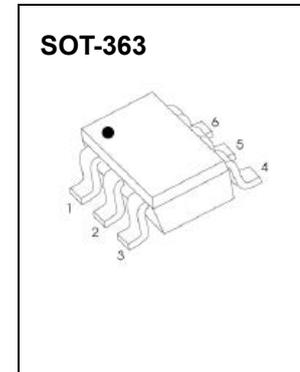


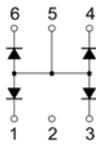
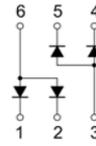
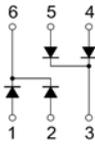
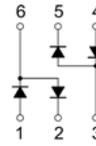
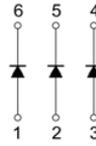
Plastic-Encapsulate Diodes

Switching Diode

FEATURES

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance Power Dissipation



MMBD4448HAEW	MMBD4448HADW	MMBD4448HCDW	MMBD4448HSDW	MMBD4448HTW
				
MARKING:KA5	MARKING:KA6	MARKING:KA7	MARKING:KAB	MARKING:KAA
				

Solid dot = Pin1 indicate.

Solid dot = Green molding compound device, if none, the normal device.

Maximum Ratings and Electrical Characteristics, Single Diode @ $T_a=25^\circ\text{C}$

Parameter	Symbol	Limit	Unit
Non-Repetitive Peak Reverse Voltage	V_{RM}	100	V
Peak Repetitive Peak Reverse Voltage	V_{RRM}	80	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_R		
RMS Reverse Voltage	$V_{R(RMS)}$	57	V
Forward Continuous Current	I_{FM}	500	mA
Average Rectified Output Current	I_O	250	mA
Non-Repetitive Peak Forward Surge Current @ $t=8.3\text{ms}$	I_{FSM}	2.0	A
Power Dissipation	P_d	200	mW
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	625	$^\circ\text{C/W}$
Storage Temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS

Electrical Ratings @Ta=25°C

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Reverse Breakdown Voltage	$V_{(BR)}$	80			V	$I_R=100\mu A$
Forward Voltage	V_{F1}	0.62		0.72	V	$I_F=5mA$
	V_{F2}			0.855	V	$I_F=10mA$
	V_{F3}			1.0	V	$I_F=100mA$
	V_{F4}			1.25	V	$I_F=150mA$
Reverse Current	I_{R1}			100	nA	$V_R=70V$
	I_{R2}			25	nA	$V_R=20V$
Capacitance Between Terminals	C_T			3.5	pF	$V_R=0V, f=1MHz$
Reverse Recovery Time	t_{rr}			4	ns	$I_F=I_R=10mA$ $I_{rr}=0.1I_{R}, R_L=100\Omega$

Typical Characteristics

